

**Chip Ferrite Bead BLM21□□□□□□Z1□**  
**Murata Standard Reference Specification[AEC-Q200]**

**1. Scope**

This reference specification applies to Chip Ferrite Bead for Automotive Electronics BLM21\_SZ Series based on AEC-Q200 except for Power train and Safety.

**2. Part Numbering**

(ex.) BL M 21 AG 121 S Z 1 D  
 (1) (2) (3) (4) (5) (6) (7) (8) (9)

(1)Product ID  
 (2)Type  
 (3)Dimension (L×W)  
 (4)Characteristics  
 (5)Typical Impedance at 100MHz  
 (6)Performance

(7)Category (for Automotive Electronics)  
 (8)Numbers of Circuit  
 (9)Packaging

D:Taping(φ 180mm Reel, Paper Tape)  
L:Taping(φ 180mm Reel, Plastic Tape)

**3. Rating**

| Customer Part Number | MURATA Part Number | Impedance (Ω)<br>(at 100MHz) (*1)<br>(refer to below comment) | Rated Current (mA)(*2) |            |            | DC Resistance (Ω) max. (*1)<br>(refer to below comment) |                      | ESD Rank<br>2:2kV<br>6:25kV |
|----------------------|--------------------|---|------------------------|------------|------------|---|----------------------|-----------------------------|
|                      |                    |   | Typical                | at 85°C    | at 125°C   | Initial Values  | Values After Testing |                             |
|                      | BLM21PG220SZ1D     | 22±25%  | 22                     | *2<br>6000 | *2<br>3300 | 0.009   | 0.018                | 2                           |
|                      | BLM21PG300SZ1D     | 20 min.   | 30                     | *2<br>4000 | *2<br>2300 | 0.014   | 0.028                |                             |
|                      | BLM21PG600SZ1D     | 60±25%  | 60                     | *2<br>3500 | *2<br>1900 | 0.02  | 0.04                 |                             |
|                      | BLM21PG121SZ1D     | 120±25%   | 120                    | *2<br>3000 | *2<br>1550 | 0.03  | 0.06                 |                             |
|                      | BLM21PG221SZ1D     | 220±25%   | 220                    | *2<br>2000 | *2<br>1250 | 0.045   | 0.09                 |                             |
|                      | BLM21PG331SZ1D     | 330±25%   | 330                    | *2<br>1500 | *2<br>1000 | 0.07  | 0.14                 |                             |
|                      | BLM21SN300SZ1D     | 30±10Ω  | 30                     | *2<br>8500 | *2<br>6000 | 0.004   | 0.005                |                             |
|                      | BLM21SP700SZ1D     | 70±25%  | 70                     | *2<br>6000 | *2<br>4000 | 0.009   | 0.012                |                             |
|                      | BLM21SP111SZ1D     | 110±25%   | 110                    | *2<br>5000 | *2<br>3300 | 0.013   | 0.016                |                             |
|                      | BLM21SP181SZ1D     | 180±25%   | 180                    | *2<br>4000 | *2<br>2600 | 0.020   | 0.025                |                             |
|                      | BLM21SP331SZ1D     | 330±25%   | 330                    | *2<br>2800 | *2<br>1900 | 0.040   | 0.051                |                             |
|                      | BLM21SP471SZ1D     | 470±25%   | 470                    | *2<br>2500 | *2<br>1700 | 0.050   | 0.063                |                             |
|                      | BLM21SP601SZ1D     | 600±25%   | 600                    | *2<br>2300 | *2<br>1500 | 0.060   | 0.074                |                             |
|                      | BLM21SP102SZ1D     | 1000±25%  | 1000                   | *2<br>1600 | *2<br>1100 | 0.120   | 0.144                |                             |

| Customer Part Number | MURATA Part Number | Impedance (Ω)<br>(at 100MHz) (*1)<br>(refer to below comment) | Rated Current (mA)(*2) |      |       | DC Resistance (Ω) max. (*1)<br>(refer to below comment) |                      | ESD Rank<br>2:2kV<br>6:25kV |
|----------------------|--------------------|---|------------------------|------|-------|---|----------------------|-----------------------------|
|                      |                    |   | Typical                | at   |       | Initial Values  | Values After Testing |                             |
|                      |                    |   |                        | 85°C | 125°C |   |                      |                             |
|                      | BLM21BB050SZ1D     | 5±25%   | 5                      | 1000 | 0.02  | 0.04  | 2                    |                             |
|                      | BLM21BB600SZ1D     | 60±25%  | 60                     | 800  | 0.13  | 0.23  |                      |                             |
|                      | BLM21BB750SZ1D     | 75±25%  | 75                     | 700  | 0.16  | 0.26  |                      |                             |
|                      | BLM21BB121SZ1D     | 120±25%   | 120                    | 600  | 0.19  | 0.29  |                      |                             |
|                      | BLM21BD121SZ1D     | 120±25%   | 120                    | 350  | 0.25  | 0.35  |                      |                             |
|                      | BLM21BB151SZ1D     | 150±25%   | 150                    | 600  | 0.21  | 0.31  |                      |                             |
|                      | BLM21BD151SZ1D     | 150±25%   | 150                    | 350  | 0.25  | 0.35  |                      |                             |
|                      | BLM21BB201SZ1D     | 200±25%   | 200                    | 500  | 0.26  | 0.36  |                      |                             |
|                      | BLM21BB221SZ1D     | 220±25%   | 220                    | 500  | 0.26  | 0.36  |                      |                             |
|                      | BLM21BD221SZ1D     | 220±25%   | 220                    | 350  | 0.25  | 0.35  |                      |                             |
|                      | BLM21BB331SZ1D     | 330±25%   | 330                    | 400  | 0.33  | 0.43  |                      |                             |
|                      | BLM21BD331SZ1D     | 330±25%   | 330                    | 300  | 0.3   | 0.4   |                      |                             |
|                      | BLM21BD421SZ1D     | 420±25%   | 420                    | 300  | 0.3   | 0.4   |                      |                             |
|                      | BLM21BB471SZ1D     | 470±25%   | 470                    | 400  | 0.4   | 0.5   |                      |                             |
|                      | BLM21BD471SZ1D     | 470±25%   | 470                    | 300  | 0.35  | 0.45  |                      |                             |
|                      | BLM21BD601SZ1D     | 600±25%   | 600                    | 300  | 0.35  | 0.45  |                      |                             |
|                      | BLM21BD751SZ1D     | 750±25%   | 750                    | 250  | 0.4   | 0.5   |                      |                             |
|                      | BLM21BD102SZ1D     | 1000±25%  | 1000                   | 250  | 0.4   | 0.5   |                      |                             |
|                      | BLM21BD152SZ1D     | 1500±25%  | 1500                   | 250  | 0.45  | 0.55  |                      |                             |
|                      | BLM21BD182SZ1D     | 1800±25%  | 1800                   | 250  | 0.5   | 0.6   |                      |                             |
|                      | BLM21BD222SZ1L     | 1600 min.   | 2250                   | 250  | 0.6   | 0.7   |                      |                             |
|                      | BLM21BD222TZ1D     | 2200±25%  | 2200                   | 200  | 0.6   | 0.7   |                      |                             |
|                      | BLM21BD272SZ1L     | 2700±25%  | 2700                   | 200  | 0.8   | 0.9   |                      |                             |
|                      | BLM21AG121SZ1D     | 120±25%   | 120                    | 1000 | 0.09  | 0.19  |                      |                             |
|                      | BLM21AG151SZ1D     | 150±25%   | 150                    | 1000 | 0.09  | 0.19  |                      |                             |
|                      | BLM21AG221SZ1D     | 220±25%   | 220                    | 900  | 0.12  | 0.22  |                      |                             |
|                      | BLM21AG331SZ1D     | 330±25%   | 330                    | 800  | 0.15  | 0.25  |                      |                             |
|                      | BLM21AG471SZ1D     | 470±25%   | 470                    | 700  | 0.18  | 0.28  |                      |                             |
|                      | BLM21AG601SZ1D     | 600±25%   | 600                    | 700  | 0.2   | 0.3   |                      |                             |
|                      | BLM21AG102SZ1D     | 1000±25%  | 1000                   | 600  | 0.27  | 0.37  |                      |                             |

• Operating Temperature : -55°C to +125°C

• Storage Temperature : -55°C to +125°C

(\*1)

**Standard Testing Conditions**

< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C )

Humidity : Ordinary Humidity (25%(RH) to 85%(RH))

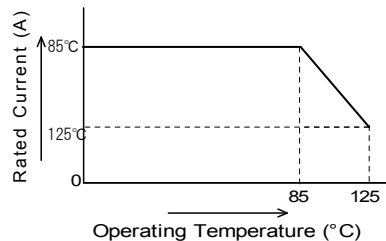
< In case of doubt >

Temperature : 20°C±2 °C

Humidity : 60%(RH) to 70%(RH)

Atmospheric pressure : 86kPa to 106kPa

(Note)As for Rated current marked with \*2,  
Rated Current is derated as right figure  
depending on the operating temperature.



**4. Style and Dimensions**



■ Equivalent Circuit



( Resistance element becomes dominant at high frequencies. )

■ Unit Mass (Typical value)

- 0.010g
- 0.014g ( for 21BD222SZ1□/21BD272SZ1□ )

| L       | W        | T  | E       |
|---------|----------|--|---------|
| 2.0±0.2 | 1.25±0.2 | 0.85±0.2                                   | 0.5±0.2 |
|         |          | for 21BD222SZ1□<br>21BD272SZ1□<br>1.25±0.2 |         |

(in mm)

**5. Marking**

No marking.

**6. Specifications**

**6-1. Electrical Performance**

| No.   | Item          | Specification | Test Method   |
|-------|---------------|---------------|---|
| 6-1-1 | Impedance     | Meet item 3.  | Measuring Frequency : 100MHz±1MHz<br>Measuring Equipment : KEYSIGHT4291A or the equivalent<br>Test Fixture : KEYSIGHT16192A or the equivalent |
| 6-1-2 | DC Resistance | Meet item 3.  | Measuring Equipment : Digital multi meter<br>*Except resistance of the Substrate and Wire   |

**6-2. Mechanical Performance (based on Table 13 for FILTER EMI SUPPRESSORS/FILTERS)**

AEC-Q200 Rev.D issued June. 1 2010

| AEC-Q200                     |  |  | Murata Specification / Deviation  |         |  |            |           |                              |  |               |              |
|------------------------------|--|--|---|---------|--|------------|-----------|------------------------------|--|---------------|--------------|
| No.                          | Stress                                   | Test Method  |   |         |  |            |           |                              |  |               |              |
| 3                            | High Temperature Exposure                | 1000hours at 125 deg C<br>Set for 24hours at room temperature, then measured.                | Meet Table A after testing.<br><table border="1" style="width: 100%;"> <thead> <tr> <th colspan="2">Table A</th> </tr> </thead> <tbody> <tr> <td>Appearance</td> <td>No damage</td> </tr> <tr> <td>Impedance Change (at 100MHz)</td> <td>Within ±30%<br/>(for BLM21SN within ±50%)</td> </tr> <tr> <td>DC Resistance</td> <td>Meet item 3.</td> </tr> </tbody> </table> | Table A |  | Appearance | No damage | Impedance Change (at 100MHz) | Within ±30%<br>(for BLM21SN within ±50%) | DC Resistance | Meet item 3. |
| Table A                      |  |  |   |         |  |            |           |                              |  |               |              |
| Appearance                   | No damage                                |  |   |         |  |            |           |                              |  |               |              |
| Impedance Change (at 100MHz) | Within ±30%<br>(for BLM21SN within ±50%) |  |   |         |  |            |           |                              |  |               |              |
| DC Resistance                | Meet item 3.                             |  |   |         |  |            |           |                              |  |               |              |
| 4                            | Temperature Cycling                      | 1000cycles<br>-55 deg C to +125 deg C<br>Set for 24hours at room temperature, then measured. | Meet Table A after testing.   |         |  |            |           |                              |  |               |              |
| 5                            | Destructive Physical Analysis            | Per EIA469<br>No electrical tests  | No defects  |         |  |            |           |                              |  |               |              |
| 7                            | Biased Humidity                          | 1000hours at 85 deg C,<br>85%RH<br>Apply max rated current.                                  | Meet Table A after testing.   |         |  |            |           |                              |  |               |              |

| AEC-Q200                           |                                       |  | Murata Specification / Deviation  |            |           |                                    |             |                  |              |
|------------------------------------|---------------------------------------|--|---|------------|-----------|------------------------------------|-------------|------------------|--------------|
| No.                                | Stress                                | Test Method  |   |            |           |                                    |             |                  |              |
| 8                                  | Operational Life                      | Apply 125 deg C<br>1000hours<br>Set for 24hours at room<br>temperature, then<br>measured   | Meet Table A after testing.<br>If the rated current of parts exceed 1A,<br>the operating temperature should be 85 deg C.  |            |           |                                    |             |                  |              |
| 9                                  | External Visual                       | Visual inspection  | No abnormalities  |            |           |                                    |             |                  |              |
| 10                                 | Physical Dimension                    | Meet ITEM 4<br>(Style and Dimensions)  | No defects  |            |           |                                    |             |                  |              |
| 12                                 | Resistance to Solvents                | Per MIL-STD-202 Method<br>215  | Not Applicable  |            |           |                                    |             |                  |              |
| 13                                 | Mechanical Shock                      | Per MIL-STD-202 Method<br>213<br>Condition F:<br>1500g's(14.7N)/0.5ms/<br>Half sine        | Meet Table B after testing.<br>Table B <table border="1" data-bbox="943 656 1455 853"> <tr> <td>Appearance</td> <td>No damage</td> </tr> <tr> <td>Impedance<br/>Change<br/>(at 100MHz)</td> <td>Within ±30%</td> </tr> <tr> <td>DC<br/>Resistance</td> <td>Meet item 3.</td> </tr> </table> | Appearance | No damage | Impedance<br>Change<br>(at 100MHz) | Within ±30% | DC<br>Resistance | Meet item 3. |
| Appearance                         | No damage                             |  |   |            |           |                                    |             |                  |              |
| Impedance<br>Change<br>(at 100MHz) | Within ±30%                           |  |   |            |           |                                    |             |                  |              |
| DC<br>Resistance                   | Meet item 3.                          |  |   |            |           |                                    |             |                  |              |
| 14                                 | Vibration                             | 5g's(0.049N) for 20<br>minutes, 12cycles each of<br>3 orientations<br>Test from 10-2000Hz. | Meet Table B after testing.   |            |           |                                    |             |                  |              |
| 15                                 | Resistance<br>to Soldering Heat       | Solder temperature<br>260C+/-5 deg C<br>Immersion time 10s                                 | Pre-heating:150C +/-10 deg,60s to 90s<br>Meet Table A after testing.  |            |           |                                    |             |                  |              |
| 17                                 | ESD                                   | Per AEC-Q200-002   | Meet Table A after testing.<br>ESD Rank: Refer to Item 3. Rating  |            |           |                                    |             |                  |              |
| 18                                 | Solderability                         | Per J-STD-002  | Method b : Not Applicable<br>95% of the terminations is to be soldered.   |            |           |                                    |             |                  |              |
| 19                                 | Electrical<br>Characterization        | Measured : Impedance   | No defects  |            |           |                                    |             |                  |              |
| 20                                 | Flammability                          | Per UL-94  | Not Applicable  |            |           |                                    |             |                  |              |
| 21                                 | Board Flex                            | Epoxy-PCB(1.6mm)<br>Deflection 2mm(min)<br>60s minimum holding time                        | Meet Table B after testing.   |            |           |                                    |             |                  |              |
| 22                                 | Terminal Strength                     | Per AEC-Q200-006   | No defects  |            |           |                                    |             |                  |              |
| 30                                 | Electrical<br>Transient<br>Conduction | Per ISO-7637-2   | Not Applicable  |            |           |                                    |             |                  |              |

**7. Specification of Packaging**

**7-1. Appearance and Dimensions**

| Part Number                                     | Type                        | Appearance and Dimensions |   |
|---|-----------------------------|---------------------------|---|
|   |                             | a                         |   |
| BLM21<br>(except<br>21BD222SZ1L<br>21BD272SZ1L) | 8mm-wide<br>Paper<br>tape   | 1.1<br>max.               |   |
|   |                             |                           |   |
| BLM21BD222SZ1L<br>BLM21BD272SZ1L                | 8mm-wide<br>Plastic<br>tape | 1.3<br>±0.1               | <p>There are holes in the cavity<br/>of the Plastic tape <math>\phi 1.0^{+0.3}_0</math></p> |

\*Dimension of the Cavity is measured at the bottom side.

(in mm)

|                           | Paper tape  | Plastic tape  |
|---------------------------|---|---|
| Taping                    | Products shall be packaged in the cavity of the base tape of 8mm-wide, 4mm-pitch continuously and sealed by top tape and bottom tape.                         | Products shall be packaged in the each embossed cavity of 8mm-wide, 4mm-pitch plastic tape continuously and sealed by cover tape. |
| Sprocket hole             | Sprocket hole shall be located on the left hand side toward the direction of feed.  |   |
| Spliced point             | The base tape and top tape have no spliced point.   | The cover tape has no spliced point.  |
| Cavity                    | There shall not be burr in the cavity.  | —   |
| Missing components number | Missing components number within 0.1% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept. |   |

**7-2. Tape Strength**

(1) Pull Strength

|              |              |          |
|--------------|--------------|----------|
| Paper tape   | Top tape     | 5N min.  |
|              | Bottom tape  |          |
| Plastic tape | Plastic tape | 5N min.  |
|              | Cover tape   | 10N min. |

(2) Peeling off force of Top tape·Cover tape

|                      |              |              |
|----------------------|--------------|--------------|
| Speed of Peeling off | 300mm/min    |              |
| Peeling off force *  | Paper tape   | 0.1N to 0.6N |
|                      | Plastic tape | 0.2N to 0.7N |

\* Minimum value is typical.

• Case of Paper tape



• Case of Plastic tape





**8. ⚠ Caution**

**8-1. Rating**

Do not use products beyond the Operating Temperature Range and Rated Current.

**8-2. Surge current**

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.

Please contact us in advance in case of applying the surge current.

**8-3. Fail Safe**

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

**8-4. Limitation of Applications**

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- |                                   |  |
|-----------------------------------|--|
| (1) Aircraft equipment            | (6) Disaster prevention / crime prevention equipment   |
| (2) Aerospace equipment           | (7) Traffic signal equipment   |
| (3) Undersea equipment            | (8) Transportation equipment (trains,ships,etc.)   |
| (4) Power plant control equipment | (9) Data-processing equipment  |
| (5) Medical equipment             | (10) Applications of similar complexity and /or reliability requirements to the applications listed in the above |

**9. Notice**

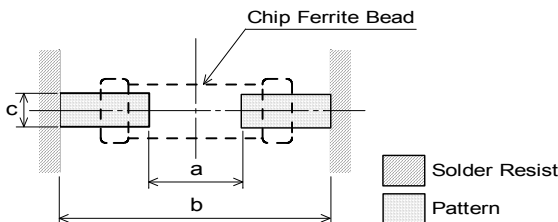
This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

**9-1. Land pattern designing**

- Standard land dimensions

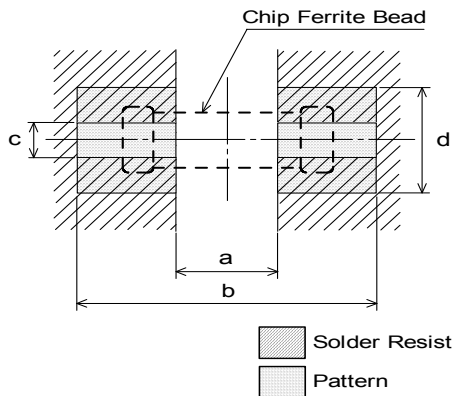
< BLM21 series(except BLM21PG/BLM21S type) >



|           |     |     |      |
|-----------|-----|-----|------|
| Soldering | a   | b   | c    |
| Flow      | 1.1 | 3.5 | 0.95 |
| Reflow    | 1.2 | 2.4 | 1.25 |

(in mm)

< For BLM21PG/S type >



| Type    | Rated Current (A) | Land pad thickness and dimension d |      |      |
|---------|-------------------|------------------------------------|------|------|
|         |                   | 18μm                               | 35μm | 70μm |
| BLM21PG | 1.5               | 1.25                               | 1.25 | 1.25 |
|         | 2                 | 1.25                               | 1.25 | 1.25 |
|         | 3~4               | 2.4                                | 1.25 | 1.25 |
|         | 6                 | 6.4                                | 3.3  | 1.65 |
| BLM21S  | 1~8.5             | -                                  | 6.8  | 3.4  |

(in mm)

|           |     |     |      |
|-----------|-----|-----|------|
| Soldering | a   | b   | c    |
| Flow      | 1.1 | 3.5 | 0.95 |
| Reflow    | 1.2 | 2.4 | 1.25 |

(in mm)

\*The excessive heat by land pads may cause deterioration at joint of products with substrate.

**9-2. Soldering Conditions**

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

|        |   |
|--------|---|
| Flux   | Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%. )<br>Do not use water-soluble flux. |
| Solder | Use Sn-3.0Ag-0.5Cu solder<br>Standard thickness of solder paste : 100 μm to 200 μm  |

(2) Soldering conditions

- Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

- Standard soldering profile and the limit soldering profile is as follows.

The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

(3) soldering profile

□Flow



|               | Standard Profile | Limit Profile     |
|---------------|------------------|-------------------|
| Pre-heating   | 150°C、60s min.   |                   |
| Heating       | 250°C、4~6s       | 265°C±3°C、5s max. |
| Cycle of flow | 2 times          | 2 times           |

□Reflow soldering profile



|                  | Standard Profile    | Limit Profile        |
|------------------|---------------------|----------------------|
| Pre-heating      | 150~180°C、90s±30s   |                      |
| Heating          | above 220°C、30s~60s | above 230°C、60s max. |
| Peak temperature | 245±3°C             | 260°C,10s            |
| Cycle of reflow  | 2 times             | 2 times              |



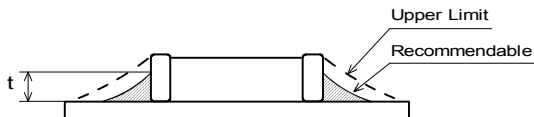
**9-3. Reworking with soldering iron**

- Pre-heating: 150°C, 1 min
- Tip temperature: 350°C max.
- Soldering time : 3(+1,-0) seconds.
- Soldering iron output: 80W max.
- Tip diameter: φ 3mm max.
- Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

**9-4. Solder Volume**

Solder shall be used not to be exceed as shown below.



$$1/3T \leq t \leq T$$

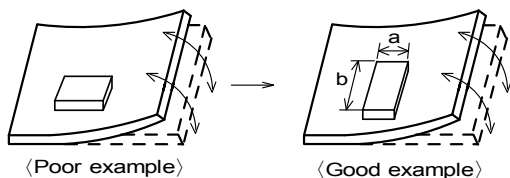
(T:Chip thickness)

Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

**9-5. Attention regarding P.C.B. bending**

The following shall be considered when designing and laying out P.C.B.'s.

- (1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage.  
 <Products direction>



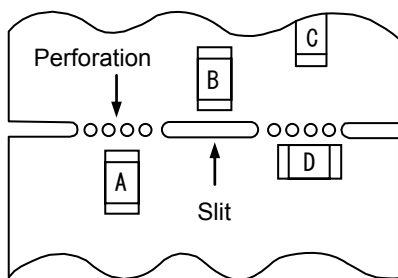
Products shall be located in the sideways direction (Length:a<b) to the mechanical stress.

- (2) Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

| Contents of Measures   | Stress Level |
|--|--------------|
| (1) Turn the mounting direction of the component parallel to the board separation surface. | A > D *1     |
| (2) Add slits in the board separation part.  | A > B        |
| (3) Keep the mounting position of the component away from the board separation surface.    | A > C        |



\*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

**(3) Mounting Components Near Screw Holes**

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.

**9-6. Mounting density**

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

**9-7. Operating Environment**

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>2</sub>, etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

**9-8. Resin coating**

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

**9-9. Cleaning Conditions**

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max. (40°C max. for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.  
Power:20W/ℓ max. Frequency:28kHz to 40kHz Time:5 min max.
- (3) Cleaner
  1. Alternative cleaner
    - Isopropyl alcohol (IPA)
  2. Aqueous agent
    - PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.  
In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning  
Please contact us.

**9-10. Handling of a substrate**

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.



**9-11.Storage Conditions**

## (1) Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

## (2) Storage conditions

- Products should be stored in the warehouse on the following conditions.

Temperature : -10°C to 40°C

Humidity : 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be stored under the airtight packaged condition.

## (3) Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

**10.  Note**

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the agreed specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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